

As the below named inventor, I hereby declare that:

the specification of which

My residence, post office address and citizenship are as stated below next to my name and that I believe I am an original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled

## **VOLTAGE REFERENCE CIRCUIT LAYOUT INSIDE MULTI-LAYERED SUBSTRATE**

X is attached her	reto.				
was filed on _					
as Application	Serial No a	nd was an	nended on	·	
I hereby state specification, includ I acknowledge application in accord I hereby claim foreign application(stany foreign application on which	that I have reviewed ing the claims, as amer the duty to disclose in dance with Title 37, Coon foreign priority beneful for patent or inventor tion for patent or inventor priority is claimed:	and undended by and formation de of Federits under 's certifica	erstand the conterny amendment refewhich is material teral Regulations, § Title 35, Untied Somethic teral sections and	erred to above. o the patentab 1.56(a). tates Code, § have also ider	ility of this 119 of any ntified below
Prior Foreign Applic	ation(s):	т			
Number	Country	Date Filed(yyyy/mm/dd)		Yes	No
91102057	Taiwan, R.O.C.	2002/2/6		X	
I hereby appoint the following attorney(s) and/or agent(s) to prosecute this application and to transact all business in the Patent and Trademark Office connected therewith:					
Jiawei Huang (Reg. No Charles C.H. Wu (Reg. No		•	Belinda Lee Maria Erlinda Sarno	(Reg. No C. (Reg. No	
SEND CORRESP	ONDENCE TO:		DIRECT TELE	PHONE CALL	

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## COMBINED DECLARATION AND POWER OF ATTORNEY CONTINUED

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patents issued thereon.

Signature //

Sole or First Joint Inventor: Jimmy Hsu

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